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Attorney Docket No.: 041993-5114

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To the Assistant Commissioner for Patents: Please record the attached original documents or copy thereof.	ATTN: BOX ASSIGNMENT	
 Name of conveying party(ies): Jin Young YOON Young Chul KIM Additional name(s) of conveying party(ies) attached? Yes X No 	2. Name and address of receiving party(ies): Name: LG Semicon Co., Ltd.	
3. Nature of conveyance: X Assignment Merger Security Agreement Change of Name Other	Street Address: 1, Hyangjeong-Dong, Hungduk-Ku, Cheongju, Choongcheongbuk-Do, Korea City: State: Zip:	
Execution Date: May 26, 199	Additional name(s) & address(es) attached? Yes _X No	
 4. Application number(s) or patent number(s): If this document is being filed together with a new application the e May 26, 1999 A. Patent Application No.(s) B. Patent No Additional numbers attached:YesXNo 		
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1	
Name: Mr. Robert J. Gaybrick Internal Address: Morgan, Lewis & Bockius LLP Customer No. 09629	7. Total fee (37 C.F.R §3.41):\$40.00X Enclosed Authorized to be charged to deposit account 50-0310	
Street Address: 1800 M Street, N.W. City: Washington State: D.C. Zip: 20036	Deposit account number: 50-0310 Attach duplicate of page if paying by deposit account	
9. Statement and Signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. J. Michael Thesz May 27, 1999 Page 1999		
Name of Person Signing V Signati 5/09/1999 DNGUYEN 00000188 09320554 FC:581 40_00 DP Total number	Date of pages including cover sheet, attachments and documents: 2	

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PATENT REEL: 010001 FRAME: 0519 05-27 13:36 THU FROM: PARK KIM & PARTNER 82-2-548-6841 TO: 12024677176

ATTORNEY DOCKET NO.: _	
SOLE/JOI	NT INVENTION
(U.S. Rights Only

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

FABRICATING METHOD OF M	1ULTI-LEVEL WIRING STRUCTURE F	OR SEMICONDUCTOR DEVICE
for which I/WE executed an application for Letters Patent on, (Serial No,		ewith; or filed an application for United States
WHEREAS, <u>LG Semicon Co., Ltd.</u> <u>Cheongiu, Choongcheongbuk-Do, Korea</u> (he in and to this invention, the application for U application;	reinafter referred to as Assignee), is desirous	ddress is 1. Hyangjeong-Dong, Hungduk-Ku, of securing the entire right, title, and interest and the Letters Patent to be issue upon this
NOW THEREFORE, be it known to acknowledged, I/WE, as assignor(s), have so unto the assignee, its lawful successors and a application, and all divisions, and continuated all reissues thereof; and I/WE hereby authoricall Letters Patent for this invention to assigne	assigns, MY/OUR entire right, title, and intere- ons thereof, and all Letters Patent of the Unite ize and reque:t the Commissioner of Patents a	o hereby sell, assign, transfer, and set over est in and to this invention and this ed States which may be granted thereon, and and Trademarks of the United States to issue
its successors and assigns, any facts known to papers when called upon to do so, execute an in said assignee, its successors and assigns, e generally do everything possible to aid assign invention in the United States, it being under assignee, its successors and assigns.	ad deliver all papers that may be necessary or xecute all divisional, continuation, and reissunce, its successors and assigns, to obtain and stood that any expense incident to the executed request the attorneys I/WE have empowered (Application No, filed	rin any legal proceeding, sign all lawful desirable to perfect the title to this invention applications, make all rightful oaths and enforce proper patent protection for this ion of such papers shall be borne by the d in the Declaration and Power of Attorney in
Full Name of Sole or First Assignor Jin Young YOON	Assignor's Signature Jin Youn Yoon	Date 5/06/99
Address Sangah Villa 401, 591-19, Kongrung 1-Do		Citizenship Republic of Korea
NAMES OF AD		

Morgan, Lewis & Bockius LLP

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PATENT REEL: 010001 FRAME: 0520

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05-27 13:37 THU FROM:PARK KIM & PARTNER 82-2-548-6841

Date Assignor's Signature Full Name of Assignor young Chal Kin Young Chul KIM Citizenship Address 166-40, Yangduk 3-Dong, Hoiwon-Ku, Masan, Kyungsangnam-Do, Korea Republic of Korea

Morgan, Lewis & Bockius LLP

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REEL: 010001 FRAME: 0521